

D1FS6

Schottky Barrier Diodes 60V, 1.1A

Feature

- Small SMD
- · High Recovery Speed
- Low V_F
- Based on AEC-Q101
- Pb free terminal
- RoHS:Yes

OUTLINE

Package (House Name): 1F
Package (JEDEC Code): DO-214AC

Equivalent circuit



Absolute Maximum Ratings (unless otherwise specified: Tl=25°C)

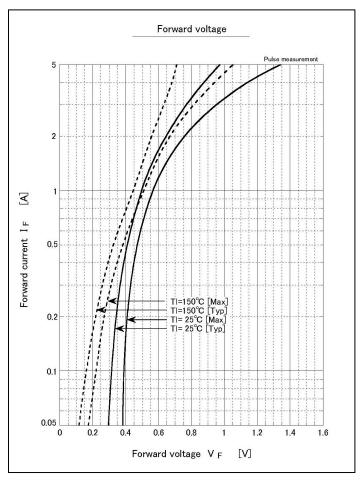
| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------------|---------------------|--|------------|------|
| Storage temperrature | Tstg | | -55 to 150 | °C |
| Junction temperature | Tj | | -55 to 150 | °C |
| Repetitive peak reverse voltage | V _{RRM} | | 60 | V |
| Repetitive peak surge reverse voltage | V_{RRSM} | Pulse width 0.5ms, duty=1/40 | 65 | V |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, On alumina substrate, Ta=49°C ※ | 1.1 | Α |
| Average forward current | I _F (AV) | 50Hz sine wave, Resistance load, On glass-epoxy substrate, Ta=48°C ※ | 0.82 | Α |
| Surge forward current | I _{FSM} | 50Hz sine wave, Non-repetitive, 1cycle, Peak value, Tj=125°C | 40 | Α |
| Repetitive peak surge reverse power | P _{RRSM} | Pulse width 10μs, Tj=25°C | 60 | W |

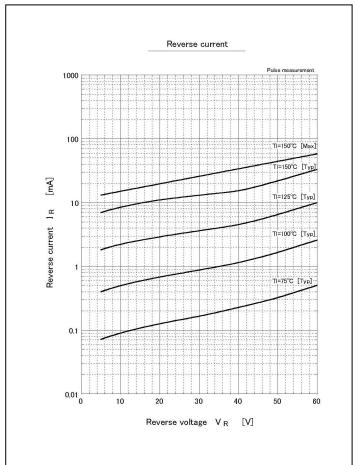
^{* :} See the original Specifications

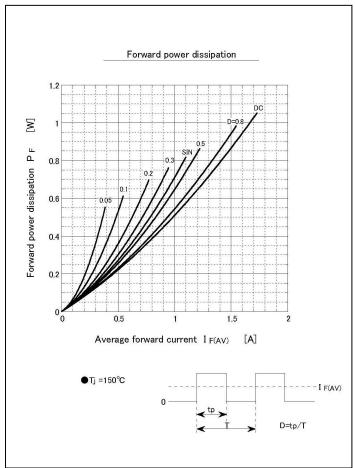
Electrical Characteristics (unless otherwise specified: Tl=25°C)

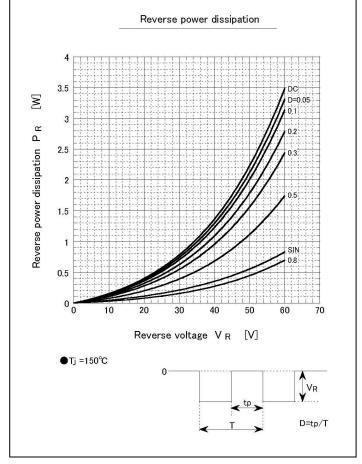
| Item | Symbol | Conditions | Ratings | | | I I mit |
|--------------------|----------------|---|---------|-----|------|---------|
| | | | MIN | TYP | MAX | Unit |
| Forward voltage | V_{F} | IF=1.1A, Pulse measurement | | | 0.58 | ٧ |
| Reverse current | I _R | VR=60V, Pulse measurement | | | 1 | mA |
| Total capacitance | Ct | f=1MHz, VR=10V | | 50 | | pF |
| Thermal resistance | Rth(j-l) | Junction to lead | | | 23 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On alumina substrate ※ | | | 108 | °C/W |
| Thermal resistance | Rth(j-a) | Junction to ambient, On glass-epoxy substrate * | | | 157 | °C/W |

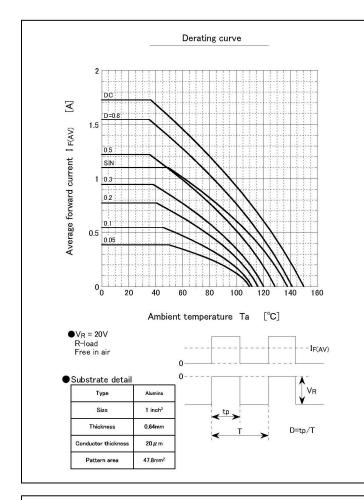
CHARACTERISTIC DIAGRAMS

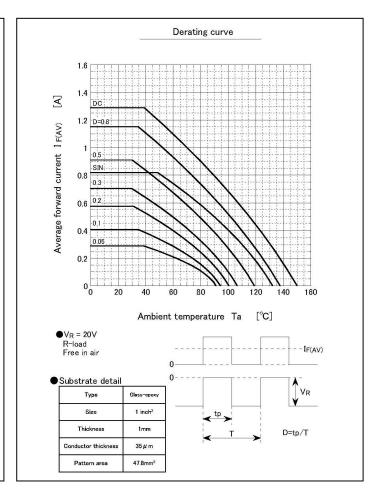


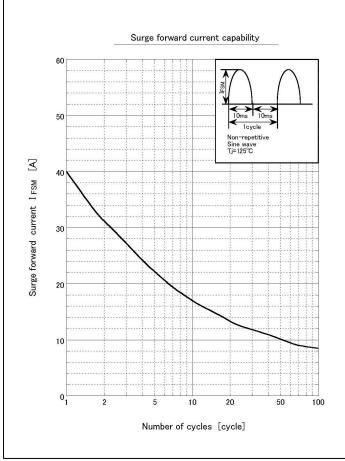


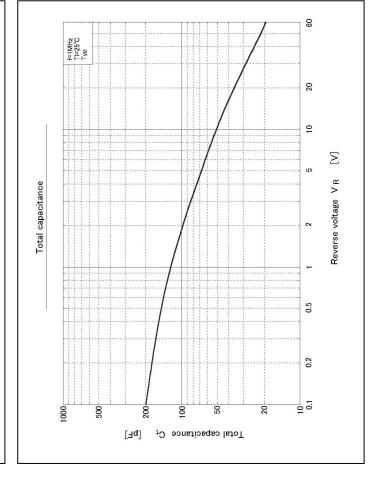


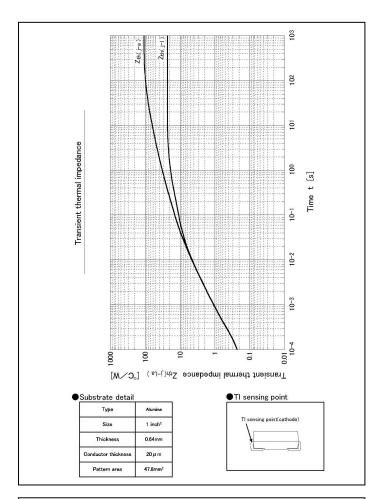


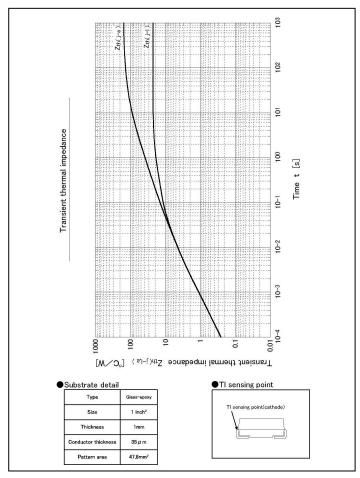


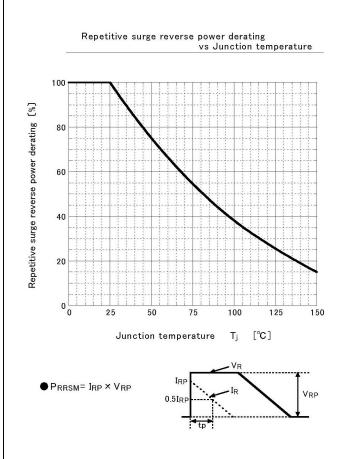


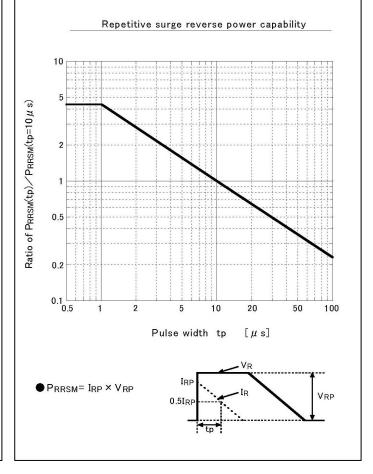










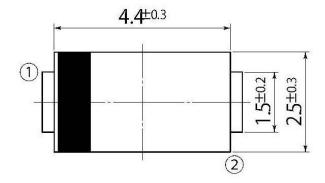


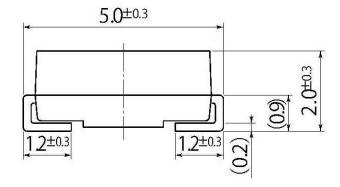
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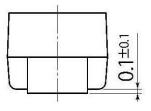
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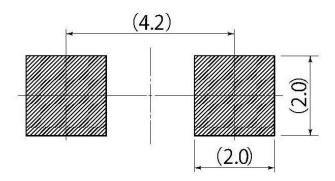
B3

| JEDEC Code | DO-214AC | | |
|------------|----------|--|--|
| JEITA Code | _ | | |
| House Name | 1F, CF | | |









Referential Soldering Pad

• Optimize soldering pad to the board design and soldering condition.

Notes

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[Specific applications]

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